PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT5899099

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
XIAOFEI WANG	07/26/2019
DINESH SOMASEKHAR	12/04/2019
CLIFFORD ONG	07/26/2019
ERIC A KARL	07/26/2019
ZHENG GUO	07/26/2019
GORDON CARSKADON	07/16/2019

RECEIVING PARTY DATA

Name:	INTEL CORPORATION
Street Address:	2200 MISSION COLLEGE BLVD.
City:	SANTA CLARA
State/Country:	CALIFORNIA
Postal Code:	95054

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16449285

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Email: Request@slwip.com

Correspondent Name: SCHWEGMAN LUNDBERG & WOESSNER, P.A.

Address Line 1: P.O. BOX 2938

Address Line 4: MINNEAPOLIS, MINNESOTA 55402

ATTORNEY DOCKET NUMBER:	(AB3896-US) 1884.677US1	
NAME OF SUBMITTER:	JANINE HEITLAND	
SIGNATURE:	/Janine Heitland/	
DATE SIGNED:	01/08/2020	

Total Attachments: 7

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RECORDATION FORM COVER SHEET PATENTS ONLY

Atty Ref/Docket No.: (AB3896-US) 1884.677US1 Patent and Trademark Office To the Director of the U.S. Patent and Trademark Office: Please record the attached original documents or copy thereof. 2. Name and address of receiving party(ies): 1. Name of conveying party(ies): Name: Intel Corporation Xiaofei Wang, Dinesh Somasekhar, Clifford Ong, Eric A Street Address: 2200 Mission College Blvd. Karl, Zheng Guo, Gordon Carskadon Additional name(s) of conveying party(ies) attached? City: Santa Clara State: CA Zip: <u>95054</u> Country: United States of America []Yes [X]No Additional name(s) & address(es) attached? []Yes [X]No 3. Nature of conveyance: [X] Assignment [] Merger [] Security Agreement [] Change of Name [] Other Execution Date: July 26, 2019, December 4, 2019, July 26, 2019, July 26, 2019, July 26, 2019, July 16, 2019 4. Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application is: A. Patent Application No.(s) B. Patent No.(s) Serial No. 16/449,285 Additional numbers attached? []Yes [X]No 6. Total number of applications and patents involved: 1 5. Name and address of party to whom correspondence concerning document should be mailed: 7. Total fee (37 CFR 3.41):\$ <u>0.00</u> Name: Viet V. Tong [[Enclosed []Authorized to be charged to deposit account Address: 190743 Schwegman Lundberg & Woessner, P.A. P.O. Box 2938 8. Please charge any additional fees or credit any over Minneapolis, Minnesota 55402 payments to our Deposit Account No.: 190743 DO NOT USE THIS SPACE Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. | Viet Tong |
Signature 6-7-20 Date Viet V. Tong/Reg. No. 45,416 Name of Person Signing Total number of pages including cover sheet: 7

Mail documents to be recorded with required cover sheet information to:

Commissioner of Patents and Trademarks Mail Stop Assignment Recordation Services P.O. Box 1450

Alexandria, VA 22313-1450

Intel Docket No.: AB3896-US SLW Reference No.: 1884.677US1

<u>ASSIGNMENT</u>

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, we, the undersigned inventor(s):

<Xiaofei Wang, Dinesh Somasekhar, Clifford Ong, Eric A Karl, Zheng Guo, Gordon Carskadon>

hereby sell, assign, and transfer to:

Intel Corporation

a corporation of Delaware, having a principal place of business at 2200 Mission College Boulevard, Santa Ciara, California, 95054 USA ("Assignee"), and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States and all other countries, in and to any and all inventions and improvements that are disclosed in the application for the patent entitled:

MULTI-BIT READ-ONLY MEMORY DEVICE

(I hereby authorize and request any attorney having appropriate authority from the assignee to insert on the designated lines below, the filing date and application number of said application when known.)

which was filed on June 21, 2019 as

United States of America Application Number 16/449,285

which has been executed by the undersigned prior hereto or concurrently herewith on the date(s) indicated below,

and in and to said application and all Additional Applications, and all other patent applications that have been or shall be filed in the United States and all other countries and international filing offices on any of said inventions and improvements; and in and to all original and reissued patents that have been or shall be issued in the United States and all other countries and international filing offices on said inventions and improvements; and in and to all rights of priority resulting from the filing of said applications; as used herein "Additional Applications" includes but is not limited to design, utility, utility model, divisional, continuing, continuation-in-part, substitute, renewal, reissue, and national phase applications on said inventions and improvements;

and agree that said Assignee may apply for and receive a patent or patents for said inventions and improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns, and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all Additional Applications, and all other patent applications on any and all said inventions and improvements; execute all rightful oaths, assignments, powers of attorney, and other papers; communicate to said Assignee, its successors,

Page 1 of 2

assigns, and legal representatives all facts known to the undersigned relating to said inventions and improvements and the history thereof; and generally assist said Assignee, its successors, assigns, or legal representatives in securing and maintaining proper patent protection for said inventions and improvements and for vesting title to said inventions and improvements, and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

	07/26/2019
Xiaq /g. W ang	Date Signed
Dinesh Somasekhar	Date Signed
	7/26/2
A AAA	Date Signed 7/26/244 Date Signed
Esia J.K. 185	Ďate Šigned 7/26/2019 Date Signed
Theng Guo	/ Date Signed
Gordon Carskadon	Date Signed

Intel Docket No.: AB3896-US SLW Reference No.: 1884.677US1

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Page 1 of 2

Intel Docket No.: AB3896-US SLW Reference No.: 1884.577US1

assigns, and legal representatives all facts known to the undersigned relating to said inventions and improvements and the history thereof; and generally assist said Assignce, its successors, assigns, or legal representatives in securing and maintaining proper patent protection for said inventions and improvements and for vesting title to said inventions and improvements, and all applications for patents and all patents on said improvements, in said Assignce, its successors, assigns, and legal representatives; and

covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Xiaofei Wang	Date Signed	
Diash	Dec 914 249	
Din esh Somusekhar	Date Signed	
Clifford Ong	Dute Signed	
Eric A Karl	Date Signed	
Zheng Guo	Date Signed	
Gordon Carskadon	Date Signed	

Intel Docket No.: AB3896-US SLW Reference No.: 1884.677US1

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(I hereby authorize and request any attorney having appropriate authority from the assignee to insert on the designated lines below, the filing date and application number of said application when known.)

which was filed on June 21, 2019 as

United States of America Application Number 16/449,285

which has been executed by the undersigned prior hereto or concurrently herewith on the date(s) indicated below,

and in and to said application and all Additional Applications, and all other patent applications that have been or shall be filed in the United States and all other countries and international filing offices on any of said inventions and improvements; and in and to all original and reissued patents that have been or shall be issued in the United States and all other countries and international filing offices on said inventions and improvements; and in and to all rights of priority resulting from the filing of said applications; as used herein "Additional Applications" includes but is not limited to design, utility, utility model, divisional, continuing, continuation-in-part, substitute, renewal, reissue, and national phase applications on said inventions and improvements;

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Intel Dacket No.: AB3896-US SLW Reference No.: 1884-677USL

assigns, and legal representatives all facts known to the undersigned relating to said inventions and improvements and the history thereof and generally assist said Assigner, its successors, assigns, or legal representatives in securing and maintaining proper patent protection for said inventions and improvements and the vesting title to said inventions and improvements, and all applications for patents and all patents on said improvements, in said Assigner, to successors assigns, and legal representatives and

coverant with said Ausignes, its successors, usages, and legal representatives that no assignment grant, mortgage, ficense, or other agreement affecting the rights and property norms convoyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Xiaofei Wang	Date Signed
Dinesh Somasekhar	Date Signed
Clifford Ong	Date Signed
Eric A Karl	Date Signed
Zheng Guo	Date Signed
Lost and and	71612019
Gordon Carskadon	Date Signed

Page 2 of 2